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BIBDATASHEET

CONFIRMATION NO. 3617

Bib Data Sheet

SERIAL NUMBER 10/632,700	FILING DATE 07/31/2003 RULE	C	CLASS 257	GROU	JP ART UNIT 2818		ATTORNEY DOCKET NO. 8750-045		
APPLICANTS									
In-Ku Kang, Chungcheongnam-do, KOREA, REPUBLIC OF;									
Hee-Kook Choi, Chungcheongnam-do, KOREA, REPUBLIC OF; Sang-Ho An, Kyunggi-do, KOREA, REPUBLIC OF;Sang-Yeop Lee, Chungcheongnam-do, KOREA, REPUBLIC OF;									
** CONTINUING DATA **********************************									
** FOREIGN APPLICATIONS ************************************									
IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 10/29/2003									
Foreign Priority claimed yes ho 35 USC 119 (a-d) conditions yes no Met after met Verified and Acknowledged Examiner's Signature Initials			STATE OR	DRAWING CLA		тот	AL	INDEPENDENT	
			COUNTRY KOREA, REPUBLIC OF			CLAI 25		CLAIMS 3	
ADDRESS MARGER JOHNSON & McCOLLOM, P.C. 1030 S.W. Morrison Street Portland, OR 97205									
TITLE Multi-chip module having bonding wires and method of fabricating the same									
	☐ All Fees								
						1.16 Fees (Filing)			
FILING FEE FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT 1.17 Fees (Processing Ext. of the processing in Paper No to charge/credit DEPOSIT ACCOUNT								essing Ext. of	